



# P-Channel 200-V (D-S) MOSFET

| PRODUCT SUMMARY     |                                  |                                 |                       |  |  |  |
|---------------------|----------------------------------|---------------------------------|-----------------------|--|--|--|
| V <sub>DS</sub> (V) | $R_{DS(on)}\left(\Omega\right)$  | I <sub>D</sub> (A) <sup>a</sup> | Q <sub>g</sub> (Typ.) |  |  |  |
| - 200               | 1.61 at V <sub>GS</sub> = - 10 V | - 0.95                          | 8 nC                  |  |  |  |
| - 200               | 1.65 at V <sub>GS</sub> = - 6 V  | - 0.93                          |                       |  |  |  |

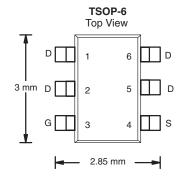
#### **FEATURES**

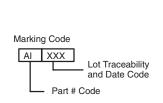
- Halogen-free According to IEC 61249-2-21 Definition
- TrenchFET<sup>®</sup> Power MOSFET
- 100 % R<sub>g</sub> and UIS Tested
- · Compliant to RoHS Directive 2002/95/EC

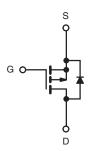


#### **APPLICATIONS**

· Active Clamp Circuits in DC/DC Power Supplies







Ordering Information: Si3475DV-T1-E3 (Lead (Pb)-free)

Si3475DV-T1-GE3 (Lead (Pb)-free and Halogen-free)

P-Channel MOSFET

| Parameter   | Symbol                            | Limit           | Unit                  |     |
|---|-----------------------------------|-----------------|-----------------------|-----|
| Drain-Source Voltage                                | V <sub>DS</sub>                   | - 200           | V                     |     |
| Gate-Source Voltage                                 | $V_{GS}$                          | ± 20            |                       |     |
|   | T <sub>C</sub> = 25 °C            |                 | - 0.95 <sup>a</sup>   |     |
| Continuous Drain Current (T <sub>.1</sub> = 150 °C) | T <sub>C</sub> = 70 °C            |                 | - 0.77                |     |
| Continuous Diain Current (1) = 150 °C)              | T <sub>A</sub> = 25 °C            | I <sub>D</sub>  | - 0.75 <sup>b,c</sup> |     |
|   | T <sub>A</sub> = 70 °C            |                 | - 0.59 <sup>b,c</sup> |     |
| Pulsed Drain Current                                |                                   | I <sub>DM</sub> | - 3                   | A   |
| Continuous Source-Drain Diode Current               | T <sub>C</sub> = 25 °C            | 1               | - 2.6                 |     |
| Continuous Source-Drain Diode Current               | T <sub>A</sub> = 25 °C            | I <sub>S</sub>  | 1.6 <sup>b,c</sup>    |     |
| Avalanche Current                                   |                                   | I <sub>AS</sub> | 3                     |     |
| Single-Pulse Avalanche Energy  L = 0.1 mH           |                                   | E <sub>AS</sub> | 0.45                  | mJ  |
|   | T <sub>C</sub> = 25 °C            |                 | 3.2                   |     |
| Manianus Davies Dissination                         | T <sub>C</sub> = 70 °C            | ь —             | 2.1                   | 14/ |
| Maximum Power Dissipation                           | T <sub>A</sub> = 25 °C            | P <sub>D</sub>  | 2 <sup>b,c</sup>      | W   |
|   | T <sub>A</sub> = 70 °C            |                 | 1.25 <sup>b,c</sup>   |     |
| Operating Junction and Storage Temperature Rang     | T <sub>J</sub> , T <sub>stq</sub> | - 55 to 150     | °C                    |     |

| THERMAL RESISTANCE RATINGS                  |              |            |         |         |      |  |
|---|--------------|------------|---------|---------|------|--|
| Parameter                                   |              | Symbol     | Typical | Maximum | Unit |  |
| Maximum Junction-to-Ambient <sup>b, d</sup> | t ≤ 5 s      | $R_{thJA}$ | 51      | 62.5    | °C/W |  |
| Maximum Junction-to-Foot                    | Steady State | $R_{thJF}$ | 32      | 39      |      |  |

#### Notes:

- a.  $T_C = 25$  °C.
- b. Surface Mounted on 1" x 1" FR4 board.
- c. t = 5 s.
- d. Maximum under Steady State conditions is 110 °C/W.



| Parameter                                     | Symbol                  | Test Conditions   | Min.  | Тур.   | Max.   | Unit   |  |
|---|-------------------------|---|-------|--------|--------|--------|--|
| Static  |                         |   |       |        |        |        |  |
| Drain-Source Breakdown Voltage                | V <sub>DS</sub>         | $V_{GS} = 0 \text{ V}, I_D = -250 \mu\text{A}$                                | - 200 |        |        | V      |  |
| V <sub>DS</sub> Temperature Coefficient       | $\Delta V_{DS}/T_{J}$   | J 050 A   |       | - 240  |        | m\//°C |  |
| V <sub>GS(th)</sub> Temperature Coefficient   | $\Delta V_{GS(th)}/T_J$ | I <sub>D</sub> = - 250 μA   |       | 6.2    |        | mV/°C  |  |
| Gate-Source Threshold Voltage                 | V <sub>GS(th)</sub>     | $V_{DS} = V_{GS}, I_{D} = -250 \mu A$   | - 2   |        | - 4    | V      |  |
| Gate-Source Leakage                           | I <sub>GSS</sub>        | $V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$                             |       |        | ± 100  | nA     |  |
| Zava Cata Valtaga Dusin Comunit               | I <sub>DSS</sub>        | V <sub>DS</sub> = - 200 V, V <sub>GS</sub> = 0 V                              |       |        | - 1    | — uA   |  |
| Zero Gate Voltage Drain Current               |                         | V <sub>DS</sub> = - 200 V, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 55 °C      |       |        | - 10   |        |  |
| On-State Drain Current <sup>a</sup>           | I <sub>D(on)</sub>      | $V_{DS} \ge -10 \text{ V}, V_{GS} = -10 \text{ V}$                            | - 2   |        |        | Α      |  |
|   | D                       | V <sub>GS</sub> = - 10 V, I <sub>D</sub> = - 0.9 A                            |       | 1.34   | 1.61   | Ω      |  |
| Drain-Source On-State Resistance <sup>a</sup> | R <sub>DS(on)</sub>     | V <sub>GS</sub> = - 6 V, I <sub>D</sub> = - 0.7 A                             |       | 1.37   | 1.65   |        |  |
| Forward Transconductance <sup>a</sup>         | 9 <sub>fs</sub>         | V <sub>DS</sub> = - 10 V, I <sub>D</sub> = - 0.9 A                            |       | 3.5    |        | S      |  |
| Dynamic <sup>b</sup>                          |                         |   |       |        |        |        |  |
| Input Capacitance                             | C <sub>iss</sub>        |   |       | 500    |        | pF     |  |
| Output Capacitance                            | C <sub>oss</sub>        | $V_{DS} = -50 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$             |       | 26     |        |        |  |
| Reverse Transfer Capacitance                  | C <sub>rss</sub>        |   |       | 18     |        |        |  |
| Tatal Cata Chayera                            | Q <sub>g</sub>          | $V_{DS} = -100 \text{ V}, V_{GS} = -10 \text{ V}, I_{D} = -1 \text{ A}$       |       | 11.7   | 18     | nC     |  |
| Total Gate Charge                             |                         |   |       | 7.8    | 12     |        |  |
| Gate-Source Charge                            |                         | $V_{DS} = -100 \text{ V}, V_{GS} = -6 \text{ V}, I_{D} = -1 \text{ A}$        |       | 2      |        |        |  |
| Gate-Drain Charge                             | Q <sub>gd</sub>         |   |       | 3.7    |        |        |  |
| Gate Resistance                               | $R_{g}$                 | f = 1 MHz   |       | 9      | 14     | Ω      |  |
| Turn-On Delay Time                            | t <sub>d(on)</sub>      |   |       | 9      | 14     |        |  |
| Rise Time                                     | t <sub>r</sub>          | $V_{DD} = -100 \text{ V}, R_{L} = 100 \Omega$                                 |       | 11     | 18     |        |  |
| Turn-Off DelayTime                            | t <sub>d(off)</sub>     | $I_D \cong$ - 1 A, $V_{GEN}$ = - 10 V, $R_g$ = 1 $\Omega$                     |       | 28     | 42     |        |  |
| Fall Time                                     | t <sub>f</sub>          | -   |       | 12     | 18     |        |  |
| Turn-On Delay Time                            | t <sub>d(on)</sub>      |   |       | 14     | 21     | ns     |  |
| Rise Time                                     | t <sub>r</sub>          | $V_{DD} = -100 \text{ V}, R_{L} = 100 \Omega$                                 |       | 29     | 44     |        |  |
| Turn-Off DelayTime                            | t <sub>d(off)</sub>     | $I_D \cong -1 \text{ A}, V_{GEN} = -6 \text{ V}, R_g = 1 \Omega$              |       | 23     | 35     |        |  |
| Fall Time                                     | t <sub>f</sub>          | -   |       | 14     | 21     |        |  |
| <b>Drain-Source Body Diode Characterist</b>   | tics                    |   |       |        |        |        |  |
| Continous Source-Drain Diode Current          | I <sub>S</sub>          | T <sub>C</sub> = 25 °C  |       |        | - 0.95 | - A    |  |
| Pulse Diode Forward Current                   | I <sub>SM</sub>         |   |       |        | - 3    |        |  |
| Body Diode Voltage                            | V <sub>SD</sub>         | I <sub>S</sub> = - 1 A, V <sub>GS</sub> = 0 V                                 |       | - 0.81 | - 1.2  | V      |  |
| Body Diode Reverse Recovery Time              | t <sub>rr</sub>         |   |       | 84     | 130    | ns     |  |
| Body Diode Reverse Recovery Charge            | $Q_{rr}$                | L = 12 A dl/dt = 100 A/vo T = 25 °C   |       | 235    | 350    | nC     |  |
| Reverse Recovery Fall Time                    | t <sub>a</sub>          | $I_F = -1.2 \text{ A, dI/dt} = 100 \text{ A/}\mu\text{s, T}_J = 25 °\text{C}$ |       | 46     |        |        |  |
| Reverse Recovery Rise Time                    | t <sub>b</sub>          |   |       | 38     |        | ns     |  |

#### Notes:

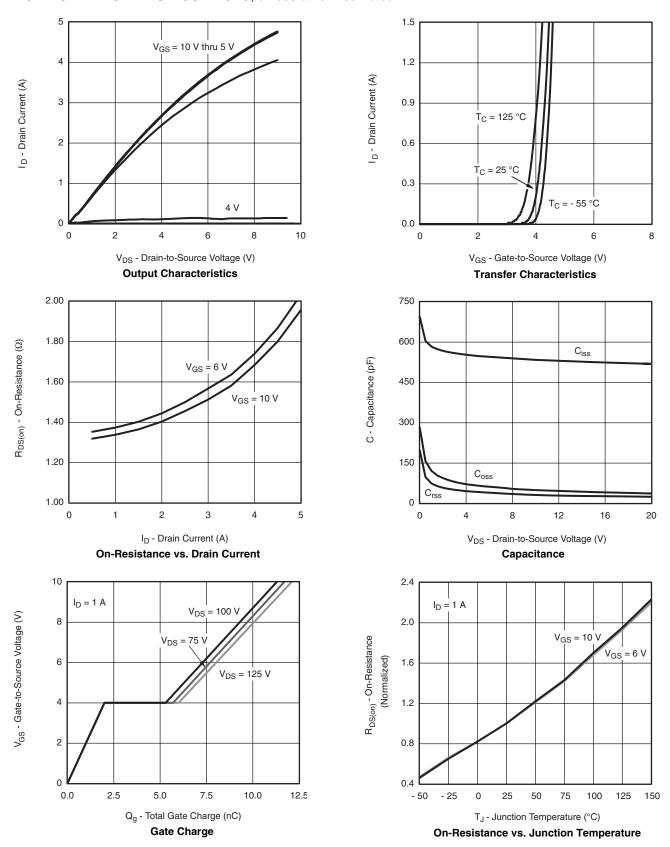
- a. Pulse test; pulse width  $\leq 300~\mu s,$  duty cycle  $\leq 2~\%.$
- b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

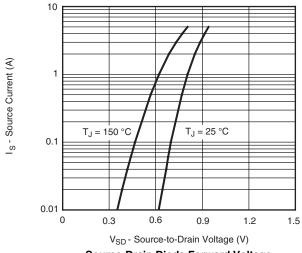




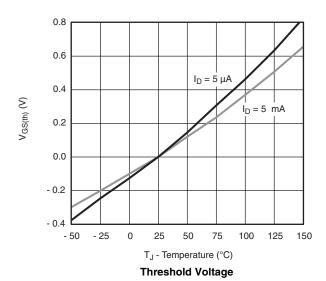
#### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



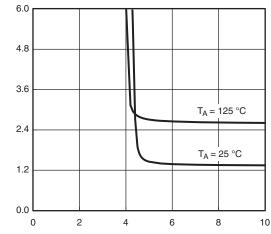
# TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



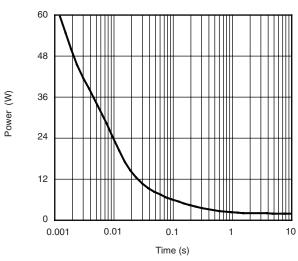
# Source-Drain Diode Forward Voltage



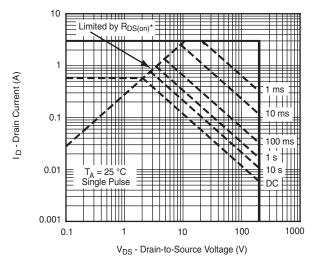
R<sub>DS(on)</sub> - Drain-to-Source (\O)



 $V_{\text{GS}}$  - Gate-to-Source Voltage (V) On-Resistance vs. Gate-to-Source Voltage



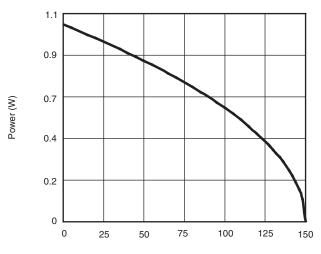
Single Pulse Power, Junction-to-Ambient



\*  $V_{GS}$  > minimum  $V_{GS}$  at which  $R_{DS(on)}$  is specified

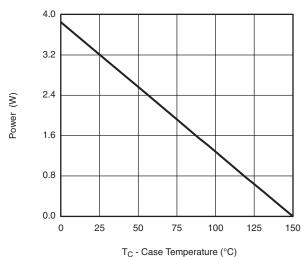
Safe Operating Area

#### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

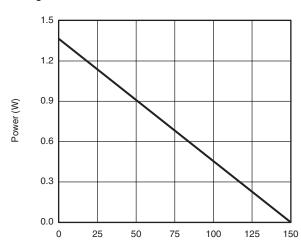


T<sub>C</sub> - Case Temperature (°C)

# **Current Derating\***



Power, Junction-to-Foot

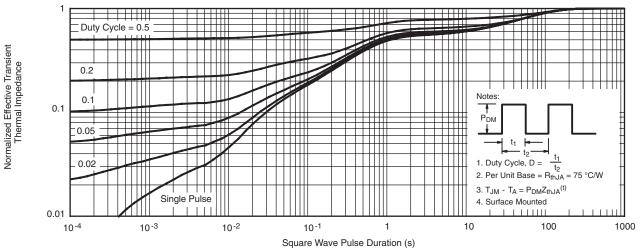


 $\label{eq:TA} T_A \text{ - Ambient Temperature (°C)}$  Power Derating, Junction-to-Ambient

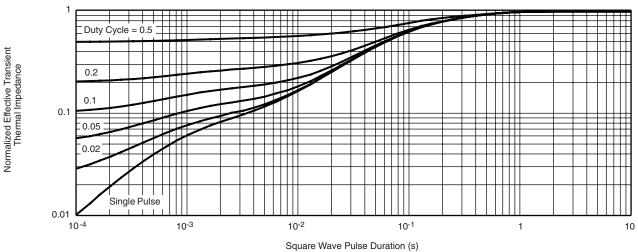
<sup>\*</sup> The power dissipation  $P_D$  is based on  $T_{J(max)} = 150$  °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

# VISHAY

# TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Foot

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